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PATENT

#4/A

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Vitali Nesterenko

Serial No.:

Filed: April 13, 2005

For: ISOSTATIC PRESSURE ASSISTED
WAFER BONDING METHOD

Group Art Unit:

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PRELIMINARY AMENDMENT

Commissioner for Patents
P.O. Box 1450
Washington, D.C. 20231

Dear Sir:

Prior to examination of this application, please amend the application as